4870–4875

Sn60/Pb40 No-Clean Solder Wires

4870–4877 electronic grade solder wires use a tin-to-lead alloy ratio, with a no-clean, synthetically refined, splatter-proof resin flux core. They melt at a higher and wider temperature range than 63/37 solder. They create robust and reliable joints that are highly resistant to whisker formation.

These leaded solders achieve a consistent solder and flux percentage thanks to our state-ofthe-art extrusion wire-drawing machine, which continuously monitors the wire to prevent voids and ensure consistency, providing a top-grade solder wire.

Features & Benefits

- Alloy exceeds J-STD-006C and meets ASTM B 32 purity requirements
- Flux meets J-STD-004B for ROM1
- Particle size Type 3
- · Excellent 12 mil fine pitch printing capability
- Long operational life—non-slumping
- · Good wettability
- Halogen-free

Available Packaging

Cat. No.	Packaging	Gauge	Diameter	Net Wt.
4870-18G	Pocket pack	21	0.032"	18 g
4875-227G	Spool	21	0.032"	227 g
4875-454G	Spool	21	0.032"	454 g

Contact Information

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Properties

Flux Classification	REL0
Flux Type	Resin
Flux Activity	Low
Copper Mirror	No removal
Corrosion Test	Pass
Electromigration	Pass
Silver Chromate–Cl- + Br-	Pass
Flux Residue Dryness	Pass
Acid Number (mgKOH/g sample)	100
Softening Point of Flux Extract	24 °C
Solder Spread	130 mm ²
Splitting of Flux-Cored Wire Solder	0.30 %
Halides (by weight)	<0.05 %
Post Reflow Flux Residue	45 %
Suface Insulation Resistance (SIR)	2.4 x 10 ¹⁰ Ω
Bellcore (Telecordia)	4.1 x 10 ¹⁰ Ω

Storage and Handling

Store refrigerated between 18–25 °C away from direct heat or sunlight.

Disclaimer

This information is believed to be accurate. It is intended for professional end-users who have the skills required to evaluate and use the data properly. M.G. Chemicals Ltd. does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.